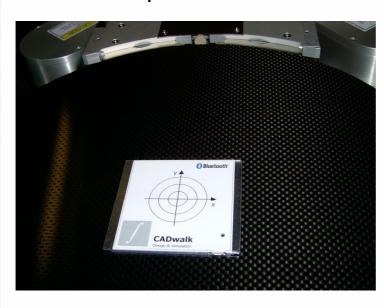
Wireless Leveling System WLS-VF

Leveling / Inclination / Parallelism

CADwalk integrates synergetic concepts to create necessary functionality at minimized costs and cost of ownership.

With a microcontroller, a dual-axis MEMS-sensor, a very thin lithium-polymer battery and an ultra flat Bluetooth transceiver we build one of the smallest, most useful, time and cost saving wireless-leveling-module for the automation-, semiconductor- and flat-panel-industry.

Semiconductor Special: WLS-VF



Key Features:

- Package: wireless sensor module only 4 mm tall.
- Keep it flat: can be put into a suitable releasing of a carbon fibre dummy wafer
- Send tilt Data of two dimensions to a PC or Laptop
- Visualisation: under Windows XP/Vista/7, intuitive bubble movement in real time, programmed in LabVIEW™, Data logging

Specifications:

Accuracy: ± 0.08 degrees
Repeatability: ± 0.08 degrees
Resolution: ± 0.03 degrees
Total range: ± 60 degrees
Communication range: 10 m
Battery life without recharging: 4.5 h

Benefits:

- The very thin wireless levelling system can be placed nearly everywhere
- o Save enormous time aligning equipment
- Increase yield, throughput and MTBF



Size: (63x66x4) mm Weight: 32 g